

NOV 02 2001

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13⁰¹/C!
under

In re application of

Serial No.: 09/293,188

Filed: April 16, 1999

For: INTERCONNECT STRUCTURE WITH
INTERLAYER DIELECTRIC

Examiner: Phat X. Cao

AMENDMENT AND RESPONSE

Box RCE
Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the Office Action mailed from the United States Patent and Trademark Office on August 3, 2001, please enter the following amendments and remarks into the file of the above-identified application.

IN THE SPECIFICATION:

Please replace the paragraph beginning at page 2, line 2, with the following rewritten paragraph: